



CY7C383A
CY7C384A

UltraLogic™ Very High Speed 2K Gate CMOS FPGA

Features

- **Very high speed**
 - Loadable counter frequencies greater than 150 MHz
 - Chip-to-chip operating frequencies up to 110 MHz
 - Input + logic cell + output delays under 6 ns
- **Unparalleled FPGA performance for counters, data path, state machines, arithmetic, and random logic**
- **High usable density**
 - 12 x 16 array of 192 logic cells provides 6,000 total available gates
 - 2,000 typically usable "gate array" gates in 68- and 84-pin PLCC, 85-pin CPGA, and 100-pin TQFP packages
- **Low power, high output drive**
 - Standby current typically 2 mA
 - 16-bit counter operating at 150 MHz consumes 50 mA
 - Minimum I_{OL} of 12 mA and I_{OH} of 8 mA
- **Flexible logic cell architecture**
 - Wide fan-in (up to 14 input gates)
 - Multiple outputs in each cell
 - Very low cell propagation delay (1.7 ns typical)
- **Powerful design tools—*Warp3*™**
 - Designs entered in VHDL, schematics, or both
 - Fast, fully automatic place and route

- Waveform simulation with back annotated net delays
- PC and workstation platforms
- **Extensive 3rd party tool support**
 - See Development Systems section
- **Robust routing resources**
 - Fully automatic place and route of designs using up to 100 percent of logic resources
 - No hand routing required
- **56 (CY7C383A) to 80 (CY7C384A) bidirectional input/output pins**
- **6 dedicated input/high-drive pins**
- **2 clock/dedicated input pins with fan-out-independent, low-skew nets**
 - Clock skew <0.5 ns
- **Input hysteresis provides high noise immunity**
- **Thorough testability**
 - Built-in scan path permits 100 percent factory testing of logic and I/O cells
- **0.65µ CMOS process with ViaLink™ programming technology**
 - High-speed metal-to-metal link
 - Non-volatile antifuse technology
- **68-pin PLCC is pinout compatible with 1K (CY7C382P) devices**
- **84-pin PLCC is pinout compatible with the 4K (CY7C385P) devices**
- **100-pin TQFP is pinout compatible with the 1K (CY7C382P) and the 4K (CY7C385P) devices**

Functional Description

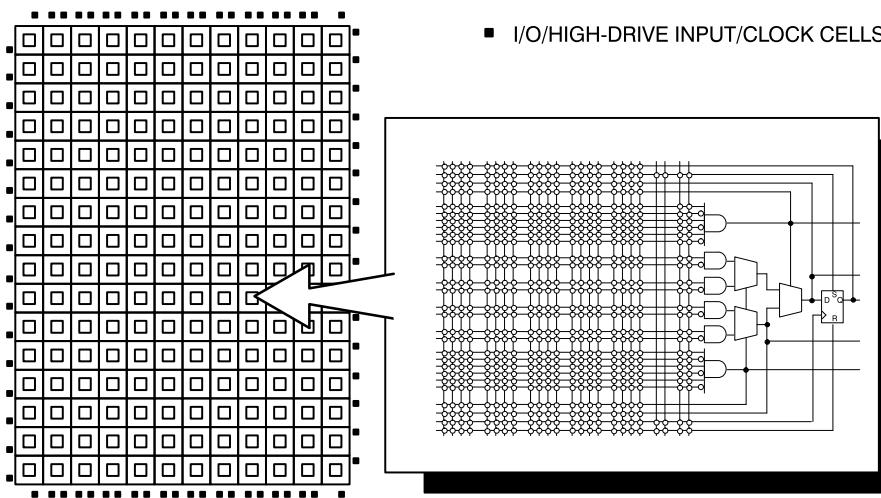
The CY7C383A and CY7C384A are very high speed CMOS user-programmable ASIC (pASIC™) devices. The 192 logic cell field-programmable gate array (FPGA) offers 2,000 typically usable "gate array" gates. This is equivalent to 6,000 EPLD or LCA gates. The CY7C383A is available in a 68-pin PLCC package. The CY7C384A is available in 84-pin PLCC, 85-pin CPGA and 100-pin TQFP packages.

Low-impedance, metal-to-metal ViaLink interconnect technology provides non-volatile custom logic capable of operating at speeds above 150 MHz with input delays under 1.5 ns and output delays under 3 ns. This permits high-density programmable devices to be used with today's fastest CISC and RISC microprocessors.

Designs are entered into the CY7C383A and CY7C384A using Cypress *Warp3* software or one of several third-party tools. See the Development Systems section of the *Programmable Logic Data Book* for more tools information. *Warp3* is a sophisticated CAE package that features schematic entry, waveform-based timing simulation, and VHDL design synthesis. The CY7C383A and CY7C384A feature ample on-chip routing channels for fast, fully automatic place and route of high gate utilization designs.

For detailed information about the pASIC380 architecture, see the pASIC380 Family datasheet.

Logic Block Diagram



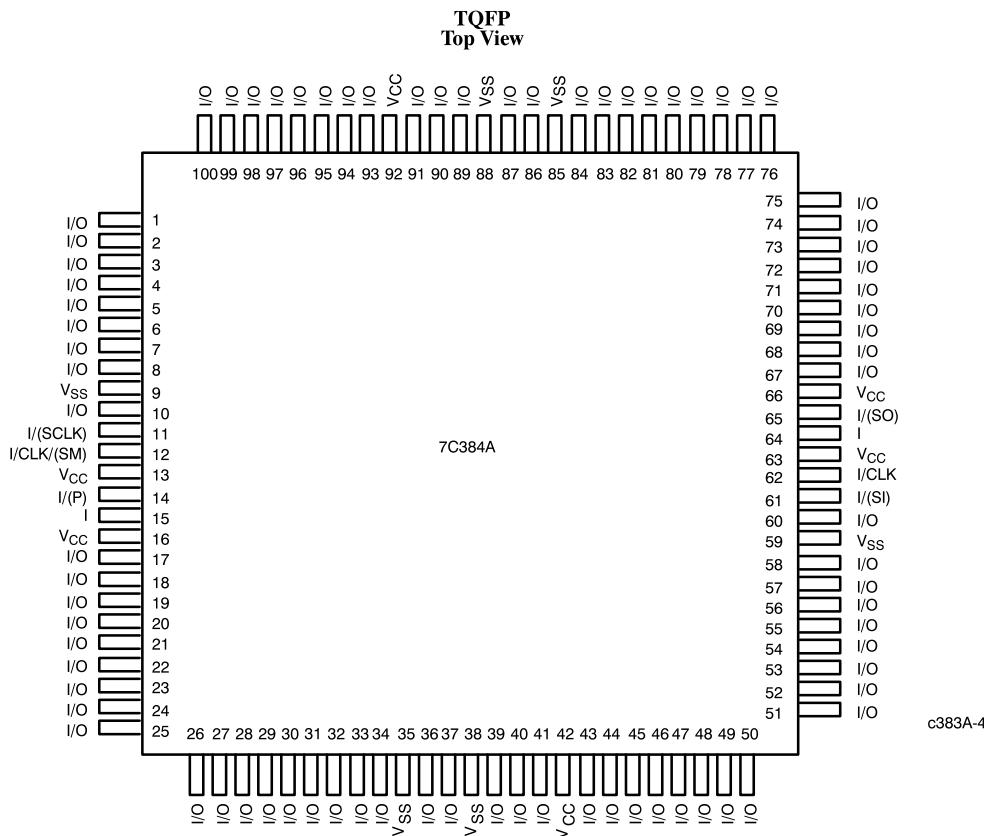
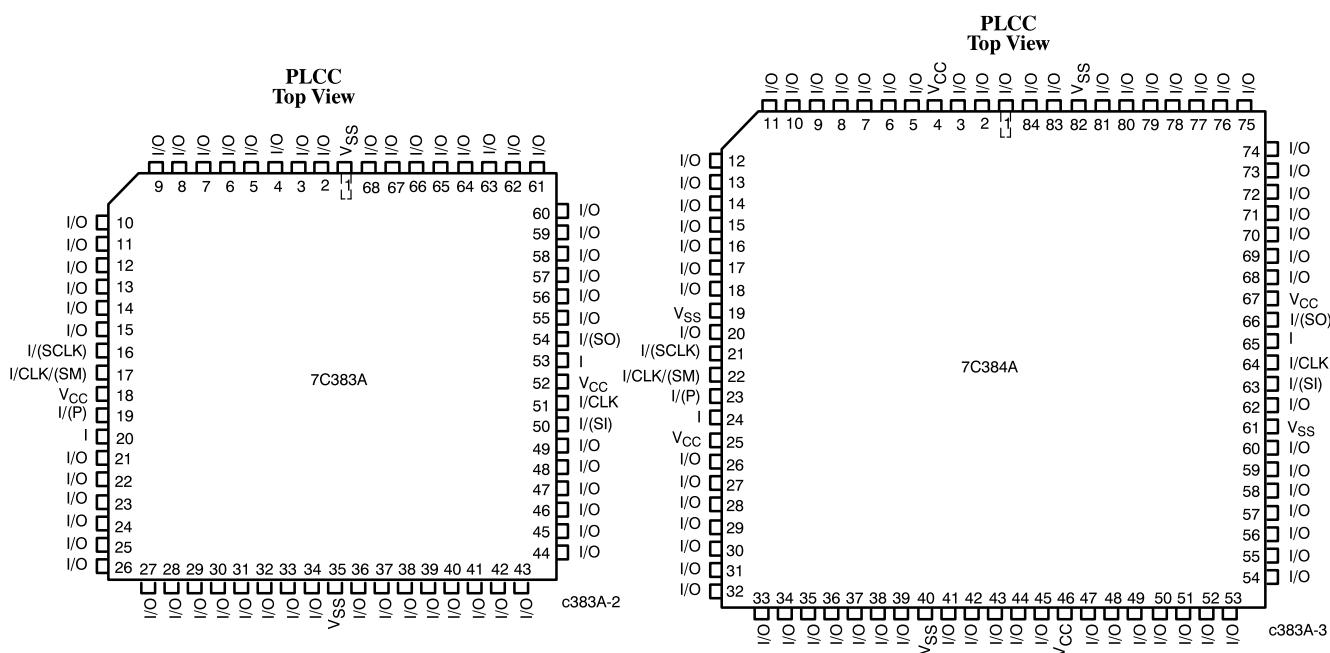
68, 84(85), or 100 PINS, INCLUDING 68 I/O CELLS, 6 INPUT HIGH-DRIVE CELLS, 2 INPUT/CLK (HIGH-DRIVE) CELLS

c383A-1

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Pin Configurations





Pin Configurations (continued)

**CPGA
Bottom View**

| | | | | | | | | | | | |
|-----|-----|-----------------|-----|-----------------|----------------|-----------------|-----|-----------------|-----|-----|-----|
| I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O |
| I/O | I/O | I/O | I/O | I/(SCLK) | I/(P) | I | I/O | I/O | I/O | I/O | I/O |
| I/O | I/O | | | V _{SS} | I/CLK/ (SM) | V _{CC} | | ■ | I/O | I/O | |
| I/O | I/O | | | | | | | | I/O | I/O | |
| I/O | I/O | V _{CC} | | | | | | V _{SS} | I/O | I/O | |
| I/O | I/O | I/O | | | | | | I/O | I/O | I/O | |
| I/O | I/O | V _{SS} | | | | | | V _{CC} | I/O | I/O | |
| I/O | I/O | | | | | | | | I/O | I/O | |
| I/O | I/O | | | V _{CC} | I/CLK | V _{SS} | | | I/O | I/O | |
| I/O | I/O | I/O | I/O | I/(SO) | I | I/(SI) | I/O | I/O | I/O | I/O | I/O |
| I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O | I/O |

11 10 9 8 7 6 5 4 3 2 1

A
B
C
D
E
F
G
H
J
K
L

c383A-5



CY7C383A

CY7C384A

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature

| | |
|---------------|-----------------|
| Ceramic | -65°C to +150°C |
| Plastic | -40°C to +125°C |

| | |
|------------------------|-------|
| Lead Temperature | 300°C |
|------------------------|-------|

| | |
|----------------------|----------------|
| Supply Voltage | -0.5V to +7.0V |
|----------------------|----------------|

| | |
|---------------------|--------------------------------|
| Input Voltage | -0.5V to V _{CC} +0.5V |
|---------------------|--------------------------------|

| | |
|--------------------------|---------|
| ESD Pad Protection | ±2000 V |
|--------------------------|---------|

| | |
|------------------------|----------------|
| DC Input Voltage | -0.5V to +7.0V |
|------------------------|----------------|

| | |
|------------------------|---------|
| DC Input Current | ±20 mA |
| Latch-Up Current | ±200 mA |

Operating Range

| Range | Ambient Temperature | V _{CC} |
|------------|---------------------|-----------------|
| Commercial | 0°C to +70°C | 5V ± 5% |
| Industrial | -40°C to +85°C | 5V ± 10% |
| Military | -55°C to +125°C | 5V ± 10% |

Delay Factor (K)

| Speed Grade | Military | | Industrial | | Commercial | |
|-------------|----------|------|------------|------|------------|------|
| | Min. | Max. | Min. | Max. | Min. | Max. |
| -X | 0.39 | 3.00 | 0.4 | 2.75 | 0.46 | 2.55 |
| -0 | 0.39 | 1.82 | 0.4 | 1.67 | 0.46 | 1.55 |
| -1 | 0.39 | 1.56 | 0.4 | 1.43 | 0.46 | 1.33 |
| -2 | | | 0.4 | 1.35 | 0.46 | 1.25 |

Electrical Characteristics Over the Operating Range

| Parameter | Description | Test Conditions | Min. | Max. | Unit |
|------------------|---|--|-----------------------|------|------|
| V _{OH} | Output HIGH Voltage | I _{OH} = -4.0 mA | 3.7 | | V |
| | | I _{OH} = -8.0 mA | 2.4 | | V |
| | | I _{OH} = -10.0 μA | V _{CC} - 0.1 | | V |
| V _{OL} | Output LOW Voltage | I _{OL} = 12 mA Commercial I _{OL} = 8.0 mA Military/Industrial | | 0.4 | V |
| | | I _{OL} = 10.0 μA | | 0.1 | V |
| | | | | | |
| V _{IH} | Input HIGH Voltage | | 2.0 | | V |
| V _{IL} | Input LOW Voltage | | | 0.8 | V |
| I _I | Input Leakage Current | V _{IN} = V _{CC} or V _{SS} | -10 | +10 | μA |
| I _{OZ} | Output Leakage Current—Three-State | V _{IN} = V _{CC} or V _{SS} | -10 | +10 | μA |
| I _{OS} | Output Short Circuit Current ^[1] | V _{OUT} = V _{SS} | -10 | -80 | mA |
| | | V _{OUT} = V _{CC} | 30 | 140 | mA |
| I _{CC1} | Standby Supply Current | V _{IN} , V _{I/O} = V _{CC} or V _{SS} | | 10 | mA |

Capacitance

| Parameter | Description | Test Conditions | Max. | Unit |
|------------------|----------------------------------|---|------|------|
| C _{IN} | Input Capacitance ^[2] | T _A = 25°C, f = 1 MHz, V _{CC} = 5.0V | 10 | pF |
| C _{OUT} | Output Capacitance | | 10 | pF |

Notes:

1. Only one output at a time. Duration should not exceed 30 seconds.
2. C_{IN} = 40 pF max. on I(SI) and I(P).



Switching Characteristics (At $V_{CC}=5V$, $T_A=25^{\circ}C$ K=1.00)

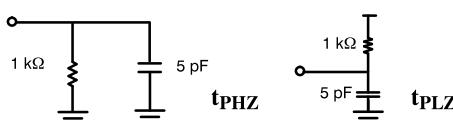
| Parameter | Description | Propagation Delays ^[3] with Fanout of | | | | | | Unit |
|--------------------|------------------------------------|--|-----|-----|-----|-----|----|------|
| | | 1 | 2 | 3 | 4 | 8 | | |
| LOGIC CELLS | | | | | | | | |
| t_{PD} | Combinatorial Delay ^[4] | 1.7 | 2.2 | 2.6 | 3.2 | 5.2 | ns | |
| t_{SU} | Set-Up Time ^[4] | 2.1 | 2.1 | 2.1 | 2.1 | 2.1 | ns | |
| t_H | Hold Time | 0.0 | 0.0 | 0.0 | 0.0 | 0.0 | ns | |
| t_{CLK} | Clock to Q Delay | 1.0 | 1.5 | 1.9 | 2.5 | 4.6 | ns | |
| t_{CWHI} | Clock HIGH Time | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 | ns | |
| t_{CWLO} | Clock LOW Time | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 | ns | |
| t_{SET} | Set Delay | 1.7 | 2.1 | 2.6 | 3.2 | 5.2 | ns | |
| t_{RESET} | Reset Delay | 1.5 | 1.9 | 2.2 | 2.7 | 4.3 | ns | |
| t_{SW} | Set Width | 1.9 | 1.9 | 1.9 | 1.9 | 1.9 | ns | |
| t_{RW} | Reset Width | 1.8 | 1.8 | 1.8 | 1.8 | 1.8 | ns | |

| Parameter | Description | Propagation Delays ^[3] | | | | | | Unit |
|--------------------|---------------------------------------|-----------------------------------|-----|-----|-----|-----|-----|------|
| | | 1 | 2 | 3 | 4 | 6 | 8 | |
| INPUT CELLS | | | | | | | | |
| t_{IN} | Input Delay (HIGH Drive) | 2.4 | 2.5 | 2.6 | 2.7 | 3.0 | 3.3 | ns |
| t_{INI} | Input, Inverting Delay (HIGH Drive) | 2.5 | 2.6 | 2.7 | 2.8 | 3.1 | 3.4 | ns |
| t_{IO} | Input Delay (Bidirectional Pad) | 1.4 | 1.9 | 2.2 | 2.8 | 3.7 | 4.6 | ns |
| t_{GCK} | Clock Buffer Delay ^[5] | 2.7 | 2.8 | 2.8 | 2.9 | 2.9 | 3.0 | ns |
| t_{GCKHI} | Clock Buffer Min. HIGH ^[5] | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 | ns |
| t_{GCKLO} | Clock Buffer Min. LOW ^[5] | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 | 2.0 | ns |

| Parameter | Description | Propagation Delays ^[3] with Output Load Capacitance (pF) of | | | | | Unit |
|---------------------|---|--|-----|-----|-----|-----|------|
| | | 30 | 50 | 75 | 100 | 150 | |
| OUTPUT CELLS | | | | | | | |
| t_{OUTLH} | Output Delay LOW to HIGH | 2.7 | 3.4 | 4.2 | 5.0 | 6.7 | ns |
| t_{OUTHL} | Output Delay HIGH to LOW | 2.8 | 3.7 | 4.7 | 5.6 | 7.6 | ns |
| t_{PZH} | Output Delay Three-State to HIGH | 4.0 | 4.9 | 6.1 | 7.3 | 9.7 | ns |
| t_{PZL} | Output Delay Three-State to LOW | 3.6 | 4.2 | 5.0 | 5.8 | 7.3 | ns |
| t_{PHZ} | Output Delay HIGH to Three-State ^[6] | 2.9 | | | | | ns |
| t_{PLZ} | Output Delay LOW to Three-State ^[6] | 3.3 | | | | | ns |

Notes:

- 3. Worst-case propagation delay times over process variation at $V_{CC} = 5.0V$ and $T_A = 25^{\circ}C$. Multiply by the appropriate delay factor, K, for speed grade to get worst-case parameters over full V_{CC} and temperature range as specified in the operating range. All inputs are TTL with 3-ns linear transition time between 0 and 3 volts.
- 4. These limits are derived from worst-case values for a representative selection of the slowest paths through the pASIC380 logic cell including net delays. Guaranteed delay values for specific paths should be determined from simulation results.
- 5. Clock buffer fanout refers to the maximum number of flip-flops per half column. The number of half columns used does not affect clock buffer delay.
- 6. The following loads are used for t_{PXZ} :

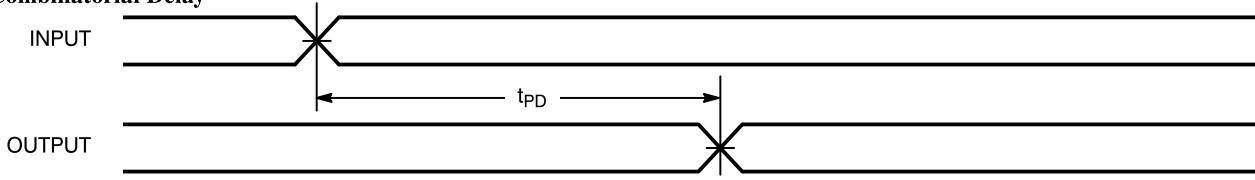


High Drive Buffer

| Parameter | Description | # High Drives Wired Together | Propagation Delays ^[3] with Fanout of | | | | | Unit |
|-----------|-----------------------------------|------------------------------------|--|-----|-----|-----|-----|------|
| | | | 12 | 24 | 48 | 72 | 96 | |
| t_{IN} | High Drive Input Delay | 1 | 4.5 | 5.4 | | | | ns |
| | | 2 | | 3.9 | 5.6 | | | ns |
| | | 3 | | | 4.5 | 5.3 | 6.3 | ns |
| | | 4 | | | | 4.6 | 5.3 | ns |
| t_{INI} | High Drive Input, Inverting Delay | 1 | 4.7 | 5.6 | | | | ns |
| | | 2 | | 4.0 | 5.8 | | | ns |
| | | 3 | | | 4.6 | 5.5 | 6.4 | ns |
| | | 4 | | | | 4.8 | 5.5 | ns |

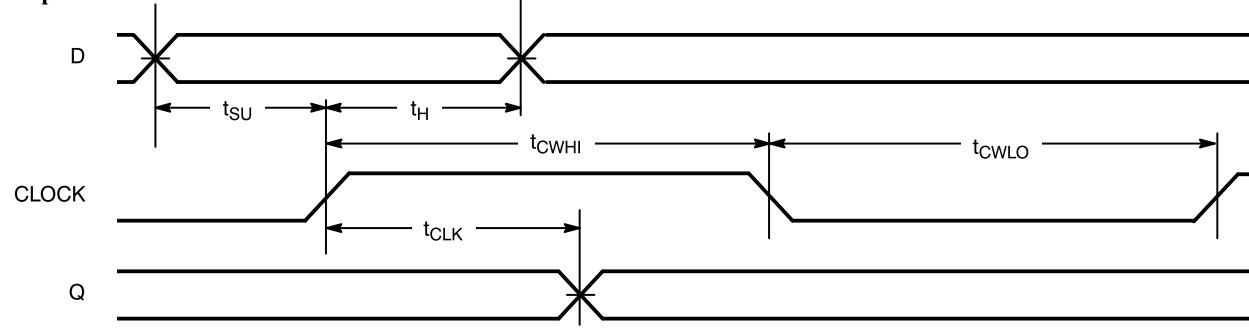
Switching Waveforms

Combinatorial Delay



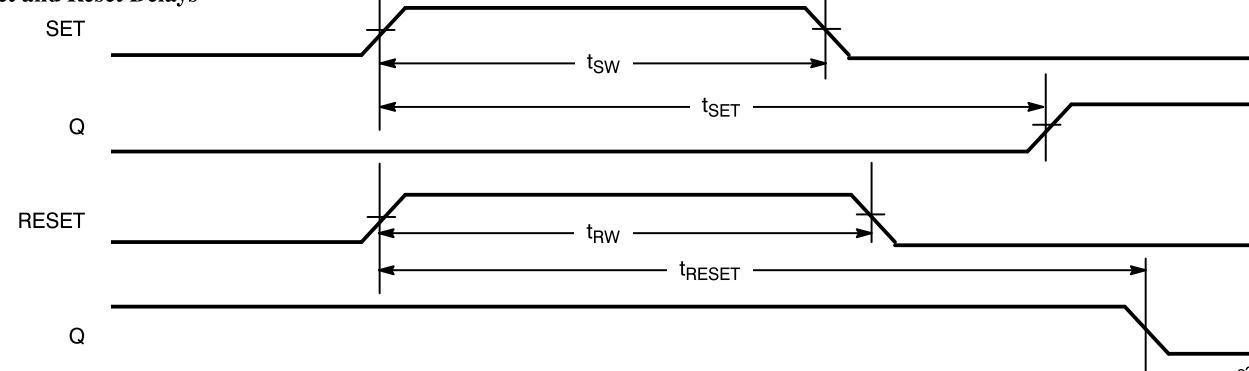
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Set-Up and Hold Times



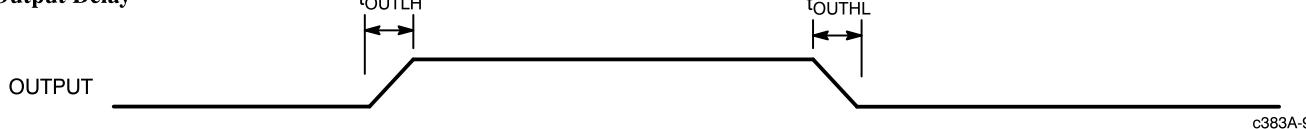
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Set and Reset Delays



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Output Delay

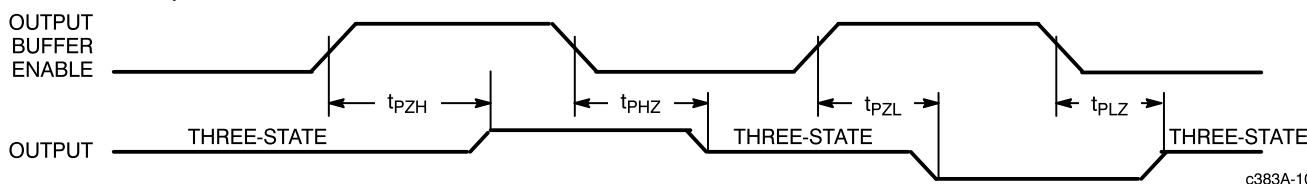


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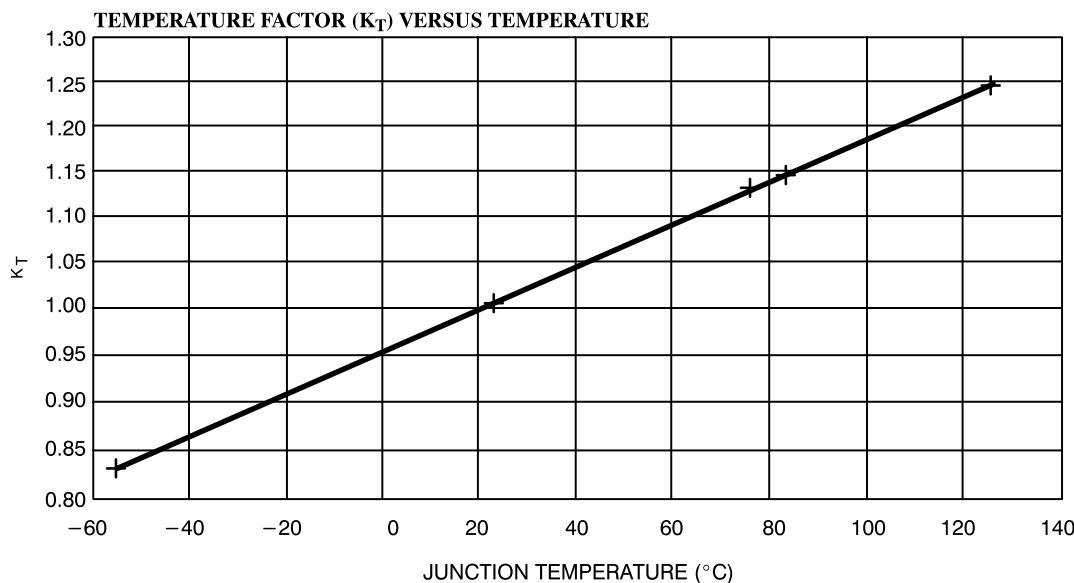
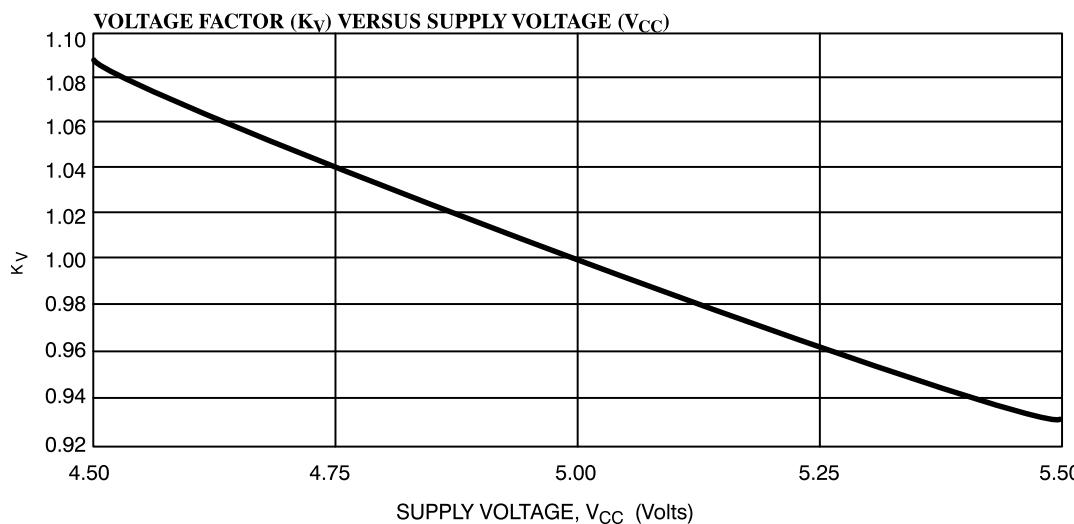
Switching Waveforms (continued)

Three-State Delay



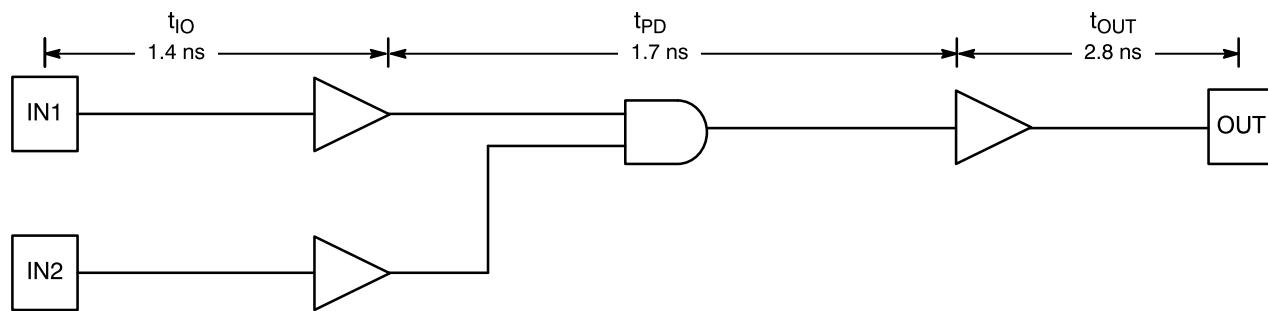
Typical AC Characteristics

Propagation delays depend on routing, fan-out, load capacitance, supply voltage, junction temperature, and process variation. The AC Characteristics are a design guide to provide initial timing estimates at nominal conditions. Worst-case estimates are obtained when nominal propagation delays are multiplied by the appropriate Delay Factor, K, as specified by the speed grade in the Delay Factor table. The effects of voltage and temperature variation are illustrated in the graphs below. The Warp3 Delay Modeler extracts specific timing parameters for precise simulation results following place and route.



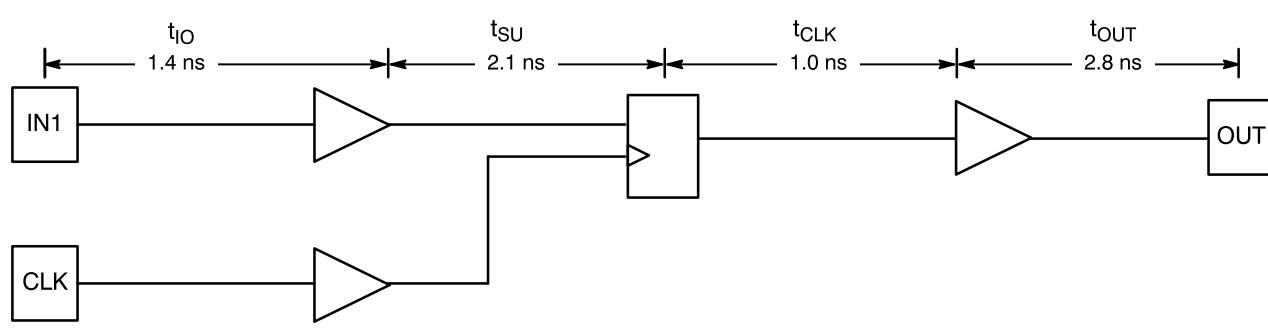
* $\theta_{JA} = 45^{\circ}\text{C/WATT}$ FOR PLCC

Combinatorial Delay Example (Load = 30 pF, K=1, Fanout=1)



c383A-13

Sequential Delay Example (Load = 30 pF, K=1, Fanout=1)



c383A-14



CY7C383A

CY7C384A

Ordering Information

| Speed Grade | Ordering Code | Package Name | Package Type | Operating Range |
|-------------|---------------|--------------|-------------------------------------|-----------------|
| 2 | CY7C383A-2JC | J81 | 68-Lead Plastic Leaded Chip Carrier | Commercial |
| | CY7C383A-2JI | J81 | 68-Lead Plastic Leaded Chip Carrier | Industrial |
| 1 | CY7C383A-1JC | J81 | 68-Lead Plastic Leaded Chip Carrier | Commercial |
| | CY7C383A-1JI | J81 | 68-Lead Plastic Leaded Chip Carrier | Industrial |
| 0 | CY7C383A-0JC | J81 | 68-Lead Plastic Leaded Chip Carrier | Commercial |
| | CY7C383A-0JI | J81 | 68-Lead Plastic Leaded Chip Carrier | Industrial |
| X | CY7C383A-XJC | J81 | 68-Lead Plastic Leaded Chip Carrier | Commercial |
| | CY7C383A-XJI | J81 | 68-Lead Plastic Leaded Chip Carrier | Industrial |

| Speed Grade | Ordering Code | Package Name | Package Type | Operating Range |
|-------------|---------------|--------------|-------------------------------------|-----------------|
| 2 | CY7C384A-2AC | A100 | 100-Pin Thin Quad Flat Pack | Commercial |
| | CY7C384A-2JC | J83 | 84-Lead Plastic Leaded Chip Carrier | |
| | CY7C384A-2AI | A100 | 100-Pin Thin Quad Flat Pack | Industrial |
| | CY7C384A-2JI | J83 | 84-Lead Plastic Leaded Chip Carrier | |
| 1 | CY7C384A-1AC | A100 | 100-Pin Thin Quad Flat Pack | Commercial |
| | CY7C384A-1JC | J83 | 84-Lead Plastic Leaded Chip Carrier | |
| | CY7C384A-1AI | A100 | 100-Pin Thin Quad Flat Pack | Industrial |
| | CY7C384A-1JI | J83 | 84-Lead Plastic Leaded Chip Carrier | |
| | CY7C384A-1GMB | G85 | 85-Pin Grid Array (Cavity Up) | Military |
| 0 | CY7C384A-0AC | A100 | 100-Pin Thin Quad Flat Pack | Commercial |
| | CY7C384A-0JC | J83 | 84-Lead Plastic Leaded Chip Carrier | |
| | CY7C384A-0AI | A100 | 100-Pin Thin Quad Flat Pack | Industrial |
| | CY7C384A-0JI | J83 | 84-Lead Plastic Leaded Chip Carrier | |
| | CY7C384A-0GMB | G85 | 85-Pin Grid Array (Cavity Up) | Military |
| X | CY7C384A-XAC | A100 | 100-Pin Thin Quad Flat Pack | Commercial |
| | CY7C384A-XJC | J83 | 84-Lead Plastic Leaded Chip Carrier | Industrial |
| | CY7C384A-XAI | A100 | 100-Pin Thin Quad Flat Pack | Commercial |
| | CY7C384A-XJI | J83 | 84-Lead Plastic Leaded Chip Carrier | Industrial |
| | CY7C384A-XGMB | G85 | 85-Pin Grid Array (Cavity Up) | Military |

Shaded area contains preliminary information.

MILITARY SPECIFICATIONS

Group A Subgroup Testing

DC Characteristics

| Parameter | Subgroups |
|------------------|-----------|
| V _{OH} | 1, 2, 3 |
| V _{OL} | 1, 2, 3 |
| I _{OZ} | 1, 2, 3 |
| I _{CC1} | 1, 2, 3 |

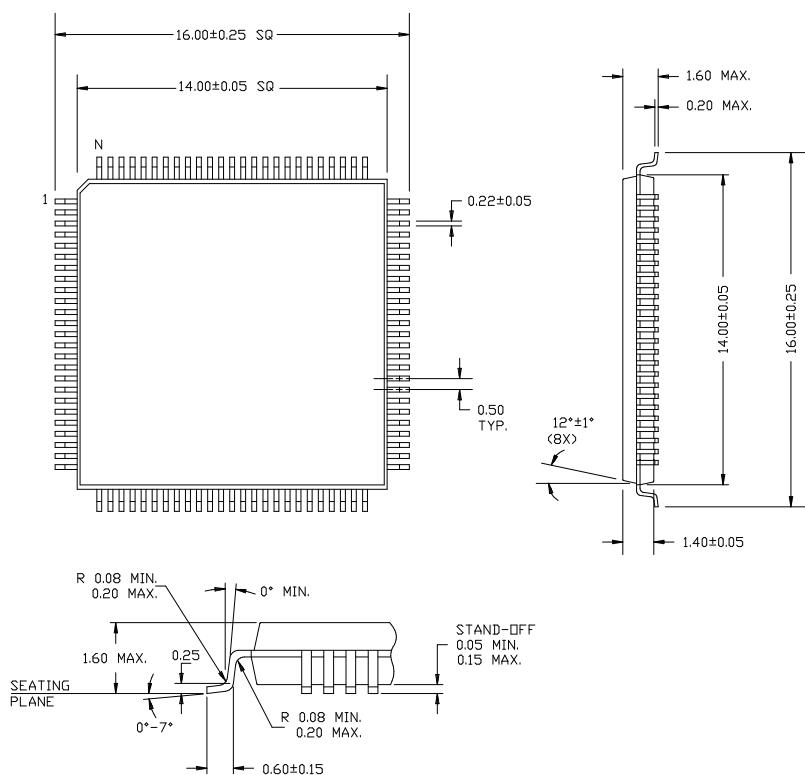
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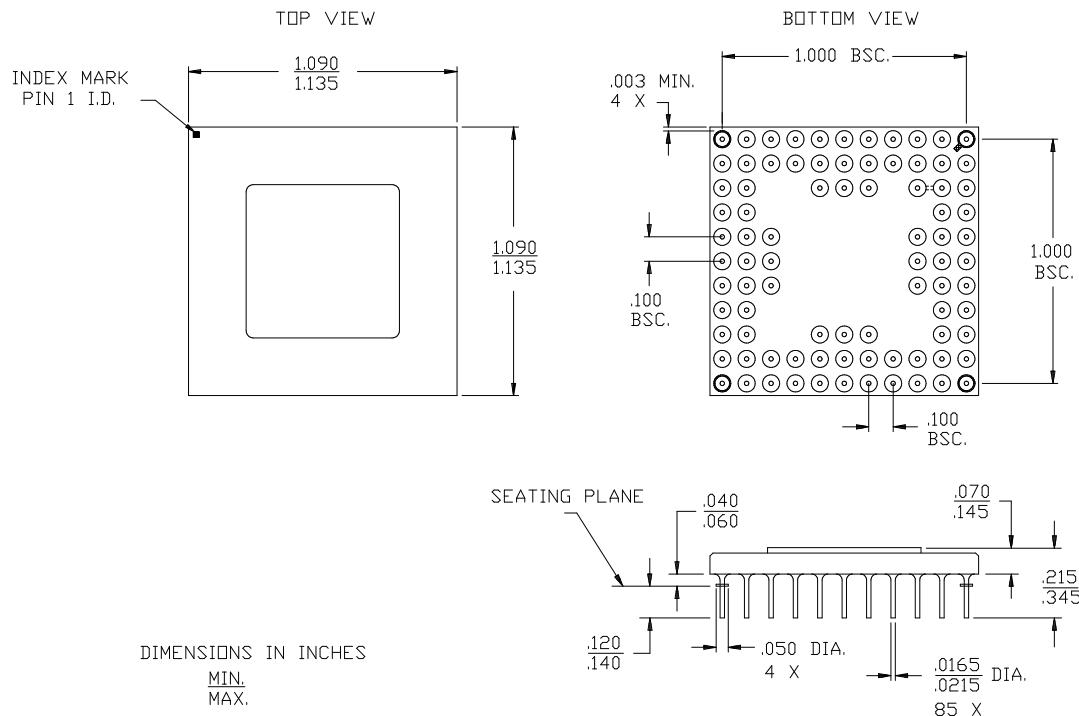
CY7C383A
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Package Diagrams

100-Pin Thin Quad Flat Pack A100



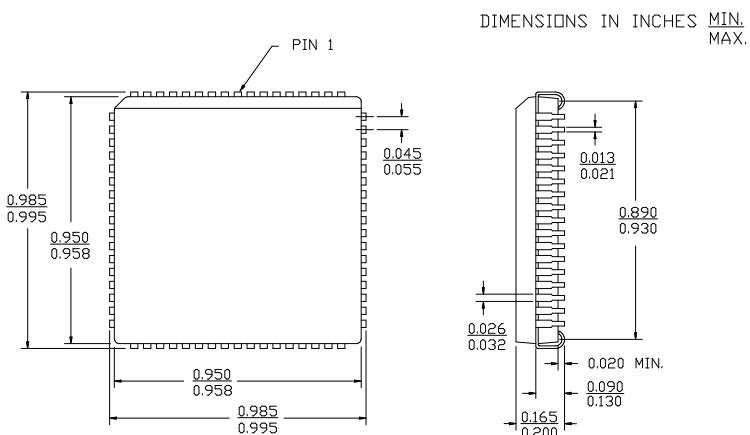
85-Pin Grid Array G85





Package Diagrams (continued)

68-Lead Plastic Leaded Chip Carrier J81



84-Lead Plastic Leaded Chip Carrier J83

